#### Phototransistors

## Panasonic

# **PNZ109CL** (PN109CL)

### Silicon planar type

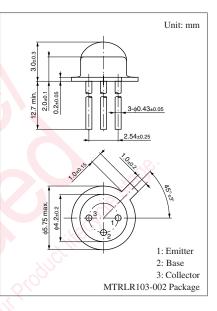
For optical control systems

#### Features

- High sensitivity:  $I_{CE(L)} = 2 \text{ mA (min.)}$
- Wide directivity characteristics for easy use
- Fast response:  $t_r = 5 \ \mu s \ (typ.)$
- Signal mixing capability using base pin
- Small size (low in height) package
- Resin to cutoff visible light is used

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

|                                       | - d              |             |      |
|---------------------------------------|------------------|-------------|------|
| Parameter                             | Symbol           | Rating      | Unit |
| Collector-emitter voltage (Base open) | V <sub>CEO</sub> | 20          | V    |
| Collector-base voltage (Emitter open) | V <sub>CBO</sub> | 30          | v    |
| Emitter-collector voltage (Base open) | V <sub>ECO</sub> | 3           | V    |
| Emitter-base voltage (Collector open) | V <sub>EBO</sub> | 5           | V    |
| Collector current                     | I <sub>C</sub>   | 20          | mA   |
| Collector power dissipation *         | P <sub>C</sub>   | 100         | mW   |
| Operating ambient temperature         | T <sub>opr</sub> | -25 to +85  | °C   |
| Storage temperature                   | T <sub>stg</sub> | -30 to +100 | °C ₀ |
|                                       |                  | 24          |      |



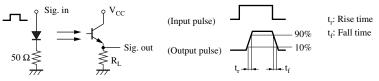
#### Electrical-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

| Parameter                               | Symbol               | Conditions  | Min | Тур  | Max  | Unit |
|---|----------------------|---|-----|------|------|------|
| Photocurrent *1                         | I <sub>CE(L)</sub>   | $V_{CE} = 10 \text{ V}, \text{ L} = 500 \text{ lx}$                                   | 2.5 | 4.0  |      | mA   |
| Dark current                            | I <sub>CEO</sub>     | V <sub>CE</sub> = 10 V  | 3   | 0.05 | 2.00 | μΑ   |
| Peak emission wavelength                | $\lambda_{p}$        | V <sub>CE</sub> = 10 V  | Q.X | 900  |      | nm   |
| Half-power angle                        | θ                    | The angle from which photocurrent becomes 50%   |     | 80   |      | 0    |
| Rise time *2                            | t <sub>r</sub>       | $V_{CC} = 10 \text{ V}, \text{ I}_{CE(L)} = 5 \text{ mA}, \text{ R}_{L} = 100 \Omega$ |     | 5    |      | μs   |
| Fall time *2                            | t <sub>f</sub>       | ist wh  |     | 6    |      | μs   |
| Collector-emitter saturation voltage *1 | V <sub>CE(sat)</sub> | $I_{CE(L)} = 1 \text{ mA}, L = 1000 \text{ lx}$                                       |     | 0.3  | 0.6  | V    |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. Spectral sensitivity characteristics: Sensitivity for wave length over 400 nm maximum sensitivity ratio is 100%.

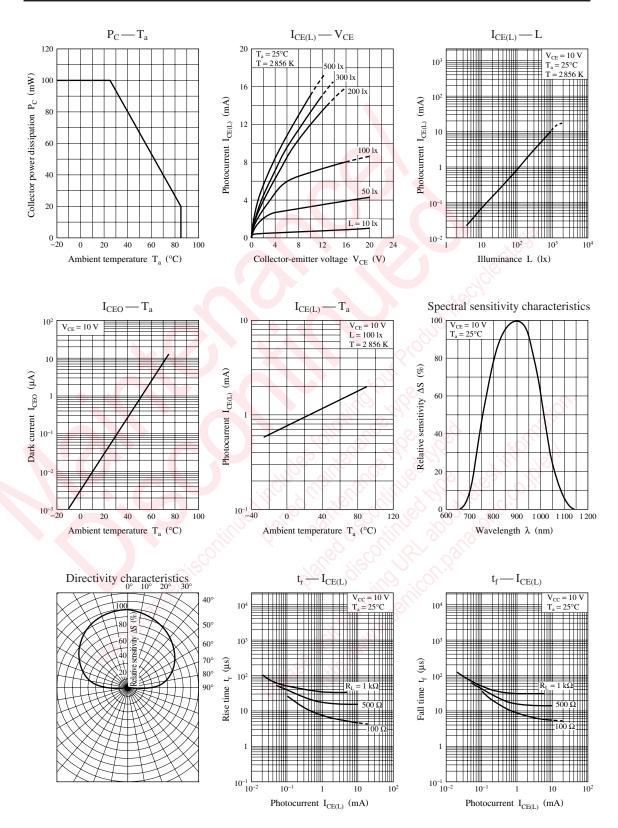
- 3. This device is designed be disregarded radiation.
- 4. \*1: Source: Tungsten (color temperature 2856 K)
  - \*2: Switching time measurement circuit



Note) The part number in the parenthesis shows conventional part number.

#### PNZ109CL





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